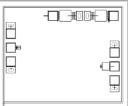
AMT1104 7 – 13GHz Power Amplifier Chip



Key Features :

- Frequency range : 7 13GHz
- Typical small signal Gain : 28dB
- Typical output power : 23.5dBm
- Voltage bias : +5V, 0.146A
- Chip dimensions : 1.35mm x 1.1mm x 0.1mm
- Applications : wireless communication, transceiver module, radio telecommunication etc.

Description:

AMT1104 chip is a Gallium Arsenide (GaAs) designed power amplifier chip, with a frequency range of 7 – 13GHz, single voltage operation, drain voltage Vds at 5V, linear gain of 28dB, saturated output power of 23.5dBm. This chip is designed with ground through metal vias on the back technology. All chip products p are 100% RF tested.

Symbol	Parameter	Value	Remark				
Vd	Drain Voltage	+11V					
Pin	Input Signal Power	15dBm					
Tch	Operating Temperature	-55 ~ +125°C					
Tm	Sintering Temperature	310°C	30s, N ₂ protection				
Tstg	Storage Temperature	-65 ~ +150°C					

Absolute Maximum Ratings (Ta = 25°C)

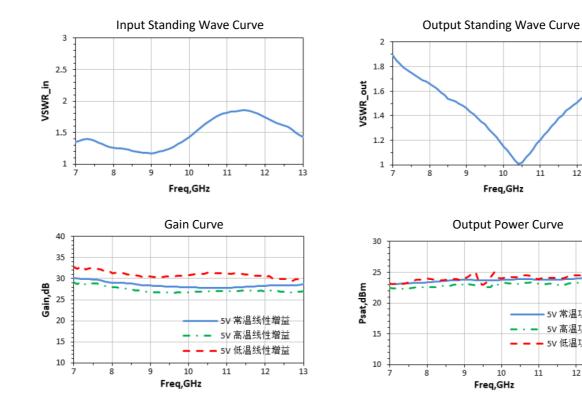
[1] Operation outside any of the Absolute Maximum Ratings may cause permanent device damage.

Electrical Characteristics (Ta = 25°C)

Symbol	Parameter	Test Condition	Value		Unit	
			Min	Typical	Max	
G	Small Signal Gain		27.6	28	30	dB
Id	Operating Current	Vd = 5V	-	146	-	mA
VSWR_in	Input SW	F : 6 ~ 18GHz	-	1.9	-	
VSWR_out	Output SW		-	2		
Gp	Power Gain	Vd = 5V	-	23.5	-	dB
Po(sat)	Saturated Output Power	F : 6 ~ 18GHz	-	23.5	-	dBm
		Duty Cycle : 20%				

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Typical Performance



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5V 常温功率

5V 高温功率

5V 低温功率

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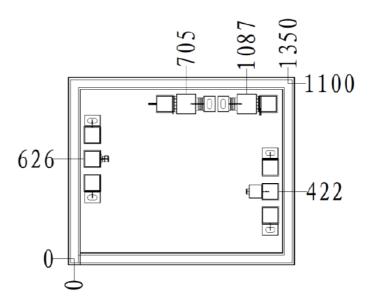
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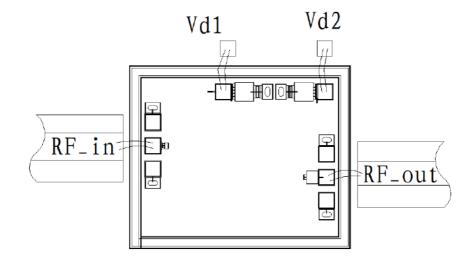
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Chip Dimensions (Unit : µm)



Chip Layout Diagram



Pad Definition

Symbol	Function	Dimension	Equivalent Circuit			
RF_in	RF signal input port, connecting to external 50 Ω system. DC blocking capacitor is not needed, if external DC current is applied to this pad.	100*100µm²	RF_in ↔			
RF_out	RF signal output port, connecting to external 50 Ω system, no need to add DC blocking capacitor.	100*100µm²	-└-└-○ RF_out			
Vd1	Amplifier drain bias, need external 100pF, 1000pF capacitor.	100*100μm²				
Vd2	Amplifier drain bias, need external 100pF, 1000pF capacitor.	100*100µm²				

Please see Appendix A for details.

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